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FDG327NZ

20V N-Channel PowerTrench^ò MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized use in small switching regulators, providing an extremely low $R_{\text{DS}(\text{ON})}$ and gate charge (Q_{G}) in a small package.

Applications

- DC/DC converter
- Power management
- Load switch



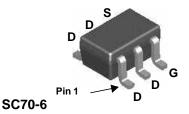
Features

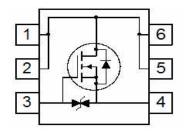
• 1.5 A, 20 V. $R_{DS(ON)} = 90 \text{ m}\Omega$ @ $V_{GS} = 4.5 \text{ V}$.

 $R_{DS(ON)}$ = 100 m Ω @ V_{GS} = 2.5 V

 $R_{DS(ON)} = 140 \text{ m}\Omega$ @ $V_{GS} = 1.8 \text{ V}$

- · Fast switching speed
- · Low gate charge
- High performance trench technology for extremely low $R_{\mbox{\scriptsize DS(ON)}}$
- High power and current handling capability.





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		± 8	
I _D	Drain Current - Continuous	(Note 1a)	1.5	А
	– Pulsed		6	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.42	W
		(Note 1b)	0.38	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	300	°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	333			

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.37	FDG327NZ	7"	8mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	,		•		•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		11		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±10	μΑ
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.4	0.7	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	ID = 250 μA, Referenced to 25°C		-2		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{aligned} &V_{GS} = 4.5 \text{ V}, & I_{D} = 1.5 \text{ A} \\ &V_{GS} = 2.5 \text{ V}, & I_{D} = 1.4 \text{ A} \\ &V_{GS} = 1.8 \text{ V}, & I_{D} = 1.2 \text{ A} \\ &V_{GS} = 4.5 \text{ V}, &I_{D} = 1.5 \text{ A}, &T_{J} = 125 ^{\circ}\text{C} \end{aligned} $		68 77 90 86	90 100 140 123	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5V$, $V_{DS} = 5 V$	3			Α
g FS	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 1.5 \text{ A}$		9		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}$		412		pF
Coss	Output Capacitance	f = 1.0 MHz		81		pF
C _{rss}	Reverse Transfer Capacitance			44		pF
R_G	Gate Resistance	$V_{GS} = 15 \text{ mV}, f = 1.0 \text{ MHz}$		1.9		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 10 \text{ V}, \qquad I_{D} = 1 \text{ A},$		6.2	13	ns
t _r	Turn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time			18	33	ns
t _f	Turn-Off Fall Time			2.9	10	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 1.5 \text{ A},$		4.2	6	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 \text{ V}$		0.4		nC
Q_{gd}	Gate-Drain Charge			1		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 0.32 \text{ A} \text{(Note 2)}$		0.6	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 1.5 \text{ A}, d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$		4		nS
Q _{rr}	Diode Reverse Recovery Charge	1		2		nC

^{1.} R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $\rm R_{\theta JC}$ is guaranteed by design while $\rm R_{\theta CA}$ is determined by the user's board design.



a) 300°C/W when mounted on a 1in² pad of 2 oz copper.



333°C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < $300\mu s$, Duty Cycle < 2.0%

Typical Characteristics

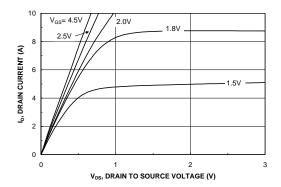


Figure 1. On-Region Characteristics.

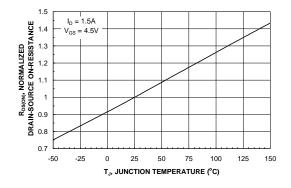


Figure 3. On-Resistance Variation withTemperature.

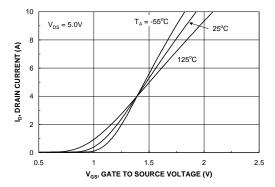


Figure 5. Transfer Characteristics.

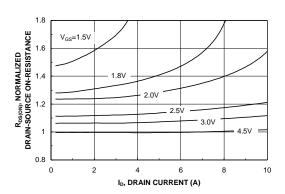


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

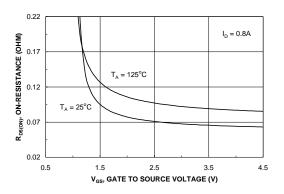


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

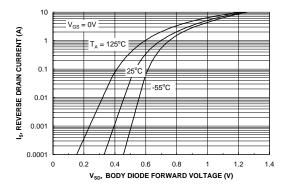
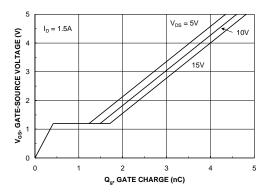


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



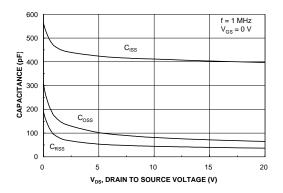


Figure 7. Gate Charge Characteristics.

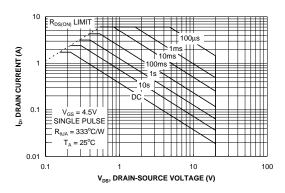


Figure 8. Capacitance Characteristics.

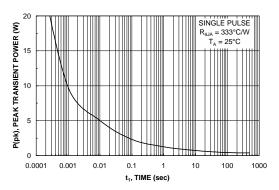


Figure 9. Maximum Safe Operating Area.



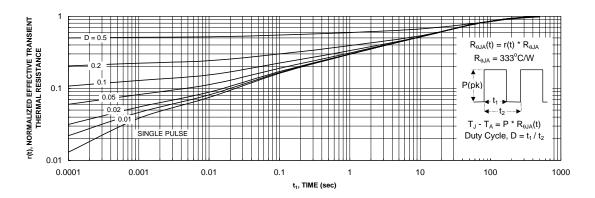


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

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